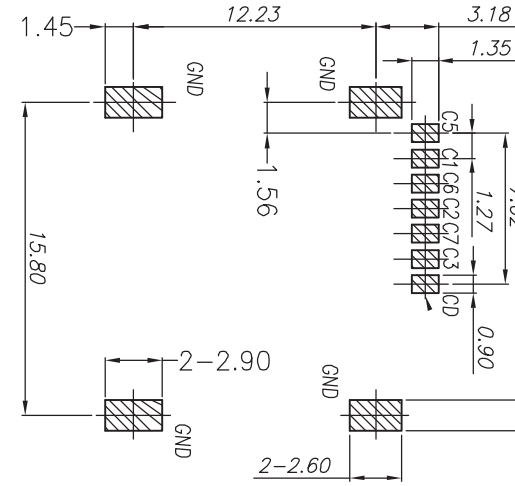
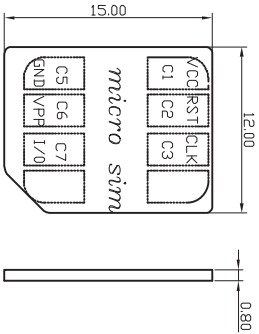
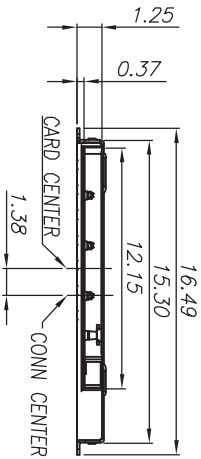
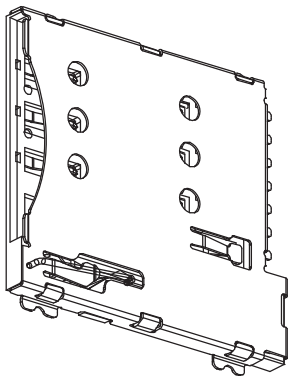
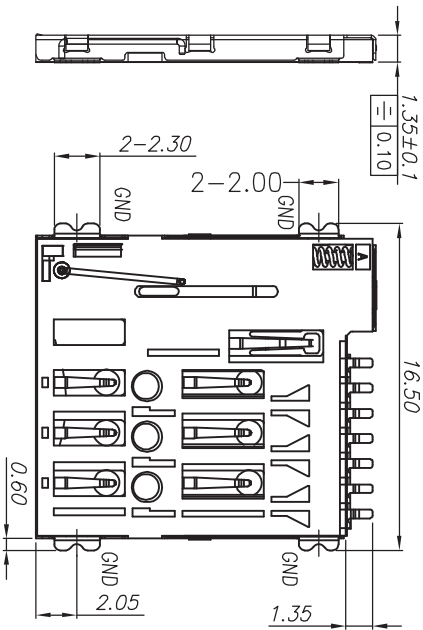


1. 此PIN为G0-PIN, 无须时, 此PIN无须设计与PCB焊盘, 实物有此PIN脚  
2. 此PIN为D0-PIN, 支持热插拔, 有须时可设计此功能。

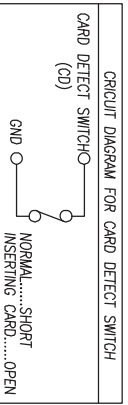


SIM pin Assignment	PIN#	Name
	C1	VCC
	C2	RST
	C3	CLK
	C5	GND
	C6	VPP
	C7	I/O

NOTES:  
MATERIAL:  
Insulator: High Temperature Thermoplastic: 94V-0.  
Contract: Copper Alloy  
Shell: STAINLESS

PLATING:  
Contract: Plated 30μm Overall Contract: 6/μm  
Shell: Plated 30μm Ni Overall  
Plated 6/μm Selective contact Area

Electrical:  
Current Rating: 0.5mA AC/DC max.  
Voltage Rating: 250V AC/DC  
Ambient Temperature Range: -20°C to 85°C  
Storage Temperature Range: -40°C to +70°C  
Ambient Humidity Range: 95% R.H. Max.  
Contract Resistance: 100kΩ max.  
Insulation Resistance: 1000MΩ min. 500VDC  
Mating Cycles: 5,000 Insertions  
Temperature: 200°C ±5



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DATE 2014/3/27

TOLERANCES UNLESS

X ± 0.50	X ± 3
X ± 0.38	X ± Z
X ± 0.25	X ± 1
.XX ± 0.10	.XX ± 0.5

TITLE: 产品名称	MICRO SIM PUSH 6+1P	UNIT	DESIGNED
PART NUMBER: 零件编号	5001-07D03T135B	SCALE	CHECKED
DRAWING NUMBER: 图纸编号		RATIO 1:1	核准
		SHEET	APPROVED
		页码 1/1	审批